General Description

The SJS20P190 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

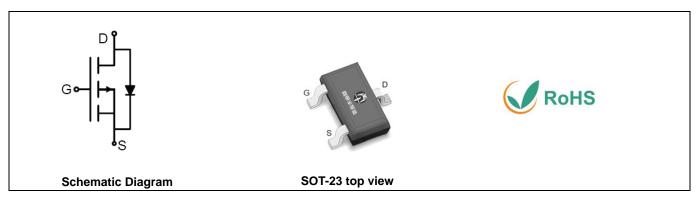
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-20	٧
R _{DS(ON)_TYP}	19.1	mΩ
I _D	-7.4	A
Q _G	14	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS20P190	2007	SOT-23	Tape	\	/	3000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-20	V
Vgs	Gate-Source Voltage (V _{DS} =0V)	±12	V
	Drain Current-Continuous(T _A =25°C)		А
I _D	Drain Current-Continuous(T _A =100°C)	-4.7	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-29.6	А
D-	Maximum Power Dissipation(T _A =25°C)		W
PD	Maximum Power Dissipation(T _A =100°C)	0.8	W
Eas	Avalanche energy (Note 2)	56	mJ
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter		Max	Unit
$R_{ hetaJA}$	R _{θJA} Thermal Resistance, Junction-to-Ambient		63	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	-20			V
	7 0 1 1/1 2 1 0 1	V _{DS} =-12V, V _{GS} =0V T _J =25°C			-1	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-12V, V _{GS} =0V T _J =125°C			100	μA
Igss	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	-1		-0.3	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-5A		17.9		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-5A T _J =25°C		19.1	24.8	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-2.5V, I _D =-4A T _J =25°C		23.5	31	mΩ
Dynamic Chara	acteristics		Į.	1	I	I
Ciss	Input Capacitance			1540		pF
C_{oss}	Output Capacitance	V _{DS} =-10V,V _{GS} =0V, f=1.0MHz		160		pF
Crss	Reverse Transfer Capacitance			154		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		5.1		Ω
Switching Para	meters		Į.	1	I	I
t _{d(on)}	Turn-on Delay Time			13		nS
t _r	Turn-on Rise Time	V _{GS} =-4.5V, V _{DS} =-10V,		32		nS
t _{d(off)}	Turn-Off Delay Time	$R_L=2\Omega$, $R_{GEN}=3\Omega$		27		nS
t _f	Turn-Off Fall Time			9		nS
Q_g	Total Gate Charge			14		nC
Q _{gs}	Gate-Source Charge	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-5A		1.2		nC
Q_{gd}	Gate-Drain Charge	1		4.8		nC
Source-Drain D	Diode Characteristics	1		1	1	1
I _{SD}	Source-Drain Current (Body Diode)				-7.4	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-5A			-1.2	V
t _{rr}	Reverse Recovery Time	I _F =-5A, dI/dt=100A/μs		160		ns
Qrr	Reverse Recovery Charge	Ir=-5A, dI/dt=100A/μs		60		nC
		1	1	1	1	

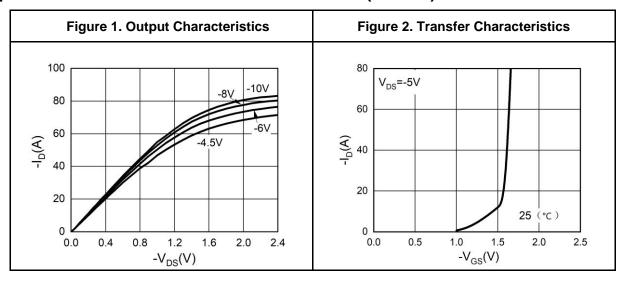
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

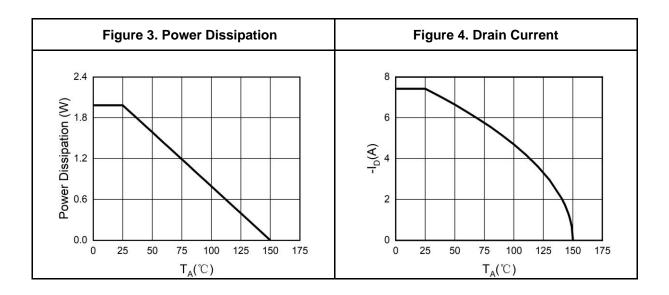
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-12V$, $V_{G}=-10V$, $Rg=25\Omega$, L=0.5mH.

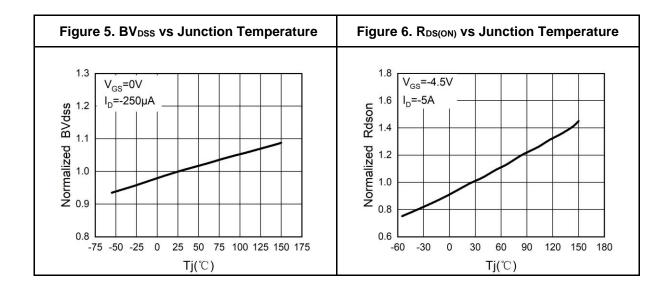
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Typical Electrical And Thermal Characteristics (Curves)

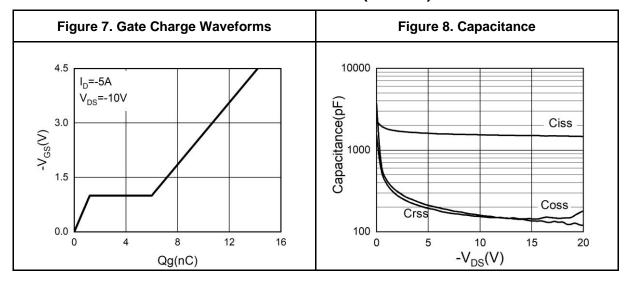


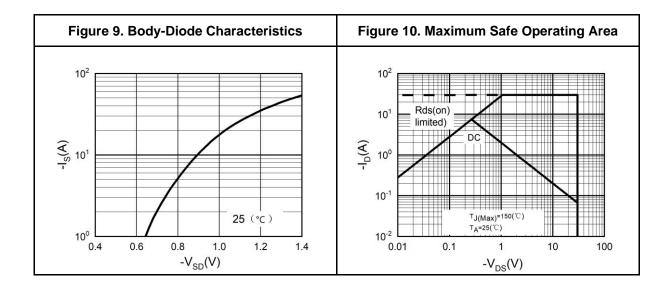






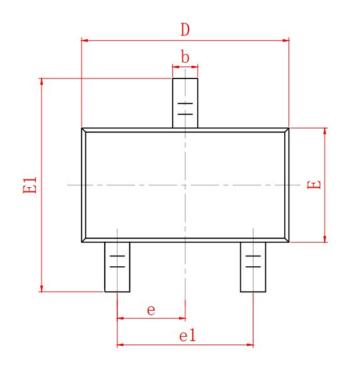
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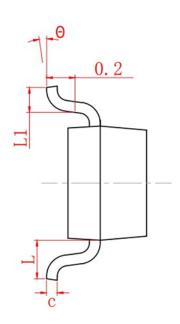


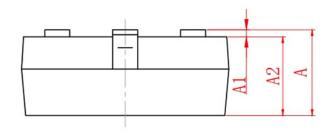




SOT-23 Package Information







SYMBOL	MIN	NOM	MAX		
А	0.90	1.05	1.20		
A1	0.00	0.05	0.10		
A2	0.90	1.00	1.10		
b	0.30	0.40	0.50		
С	0.08	0.10	0.15		
D	2.80	2.90	3.00		
E	1.20	1.30	1.40		
E1	2.30	2.30 2.40 2.50			
L	0.30	0.40	0.50		
θ	0°	5°	10°		
L1	0.55 REF				
е	0.95 BSC				
e1	1.90 REF				

Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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